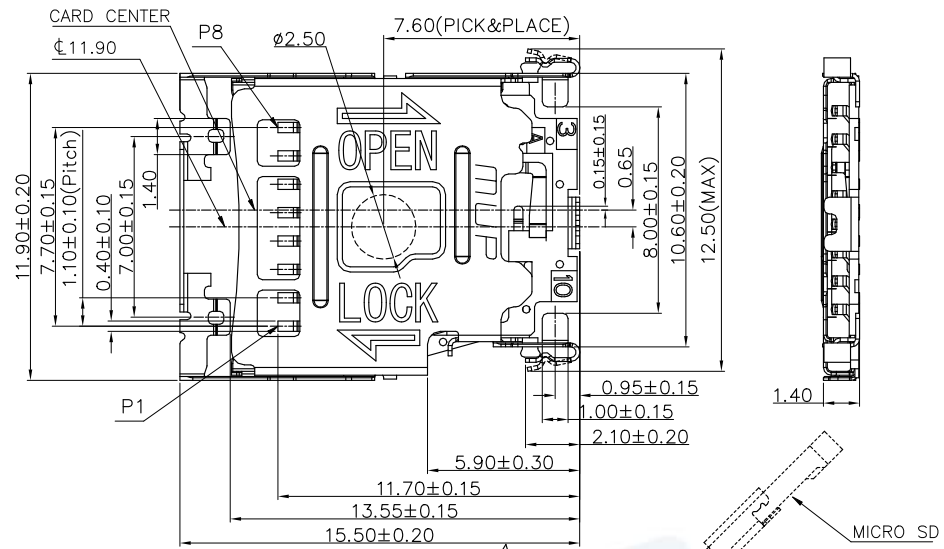
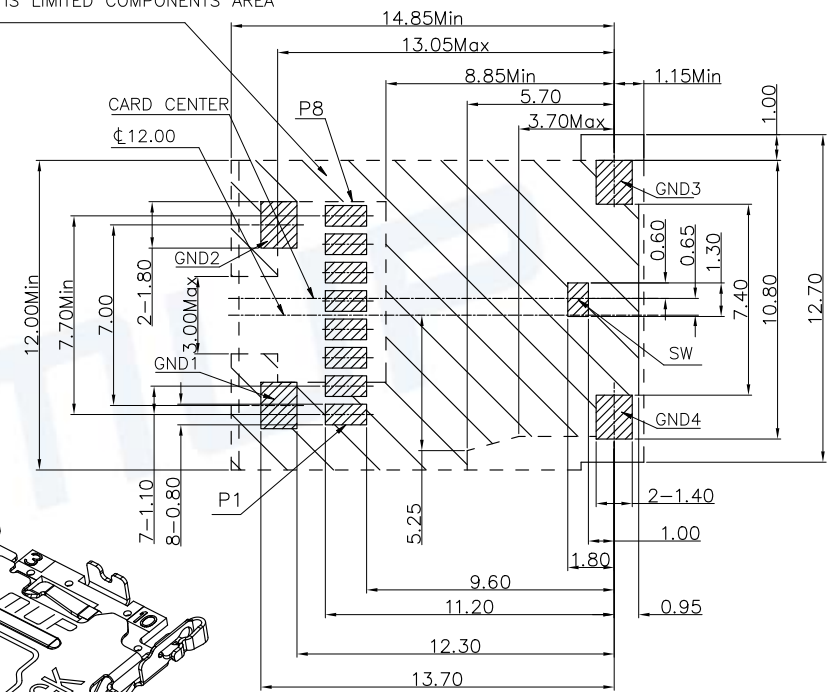


REV.	DESCRIPTION OF REVISIONS	APPR.	CHKD.	DRAW.	DATE
△	NEW			Henry	2024/03/06
△					

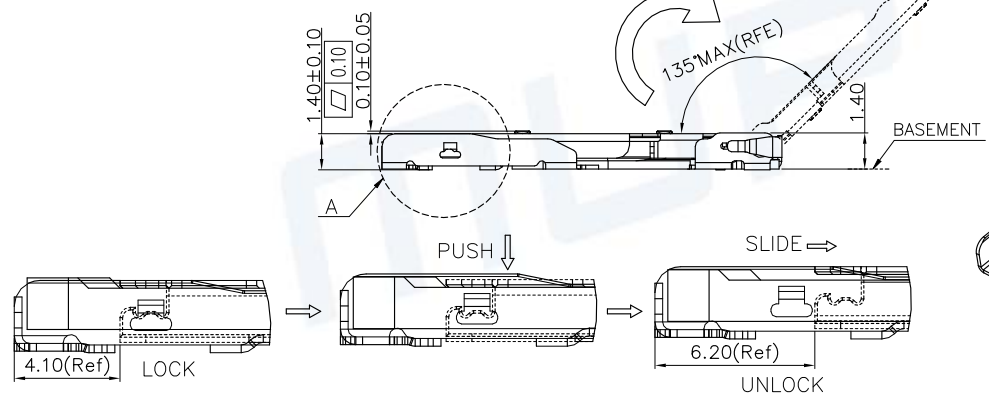


HATCHED IS LIMITED COMPONENTS AREA

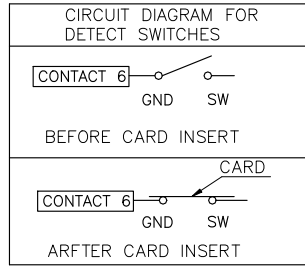


RECOMMENDED PCB LAYOUT
(ALL TOLERANCE ARE ±0.05)

- ▨ PAD AREA
- ▨ NO PATTERN AND VIA HOLE IN THIS AREA



Pin No.	
PIN1	DAT2
PIN2	CD/DAT3
PIN3	CMD
PIN4	VDD
PIN5	CLK
PIN6	VSS
PIN7	DAT0
PIN8	DAT1



TECHNICAL CHARACTERISTICS
1.General Characteristics
Dimensions:15.5LX11.9Wx1.40H mm
Durability:3,000 cycles min.
2.Electrical Characteristics
Contact resistance: 50mΩ typical,100mΩ max
Insulation resistance:>1000MΩ/500V DC
3.Solderability
Vapor phase:215°C,30sec.Max
IR reflow:260°C,10sec.Max
Manual soldering:370°C,3sec.Max
4.Environmental Characteristics
Operating temperature:-25°C~+85°C
Operating humidity:10%~+95%RH



4	CD PIN	1	Copper Alloy	Contact area:Gold plated						
3	SHELL	1	Stainless Steel	SMT area:Gold plated						
2	TEMINAL	8	Copper Alloy	Contact area:15u”Au plated						
1	HOUSING	1	Hi-temp Thermoplastic	Black UL94V-0						
No.	DESCRIPTION	Q'TY	MATERIAL	FINISH						
Unless otherwise specified, other tolerance are:			MUP[®] MUP INDUSTRIAL CO.,LTD.							
X	±0.35	X*	±5*	NAME: MicroSD CARD CONNECTOR						
X.X	±0.25	X.X*	±4*	MODEL NO: MUP-M6111-01 TYPE : Without Post / Normally Open						
X.XX	±0.15	X.XX*	±3*							
X.XXX	±0.10	X.XXX*	±2*							
PROJ.		UNIT	SCALE	DRAWN	Henry	2024/03/06	DWG NO.:	DWG-M6111-01-01		
CUSTOMER DRAWING				CHECKED	Henry	2024/03/06	SHEET	1/1	REVISION	1
				APPROVAL	Simon	2024/03/06				